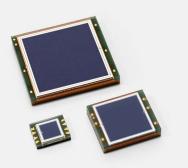


Si photodiodes



S16008 series

Si photodiodes for visible to near infrared region

The S16008 series is a surface mount type Si photodiode with high sensitivity in the visible to near infrared region. This provides higher sensitivity than the previous S2387 series.

Features

- High sensitivity in visible to near infrared region
- → Low dark current
- ⇒ Superior linearity
- Compatible with lead-free solder reflow

Applications

- Analytical instruments
- Optical measurement equipment
- PCR testing equipment

Structure / Absolute maximum ratings

				Refractive	Absolute maximum ratings			
Type no.	Photosensitive area size	Package	Window material	index of window material	Reverse voltage VR	Operating temperature Topr*1	Storage temperature Tstg*1	Soldering temperature
	(mm)			materiai	(V)	(°C)	(°C)	(°C)
S16008-33	2.4 × 2.4							260
S16008-66	5.8×5.8	Glass epoxy	Silicone resin	1.54	30	-40 to +100	-40 to +100	260 (3 times)* ²
S16008-1010	10 × 10							(5 tilles)

^{*1:} No dew condensation.

When there is a temperature difference between a product and the surrounding area in high humidity environments, dew condensation may occur on the product surface. Dew condensation on the product may cause deterioration in characteristics and reliability.

S16008-33: JEDEC J-STD-020 MSL 2a, S16008-66: JEDEC J-STD-020 MSL 3, S16008-1010: JEDEC J-STD-020 MSL 4

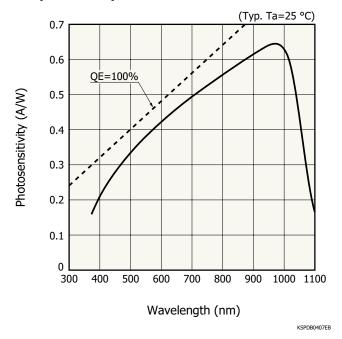
Note: Exceeding the absolute maximum ratings even momentarily may cause a drop in product quality. Always be sure to use the product within the absolute maximum ratings.

■ Electrical and optical characteristics (Ta=25 °C)

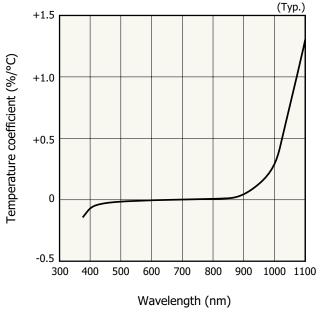
Type no.	Spectral response range	Peak sensitivity wavelength λp	Photosensitivity S λ=λp	I VR=1	rent D	Temp. coefficient of ID ΔTID	Rise time tr VR=0 V $RL=1$ $k\Omega$ 10 to 90%	Terminal capacitance Ct VR=0 V f=1 MHz	Noise equivalent power NEP VR=0 V $\lambda=\lambda p$	Shu resist Rs VR=10 Min.	ance sh 0 mV
	(nm)	(nm)	(mA/W)	(pA)	(pA)	(times/°C)	(µs)	(nF)	(W/Hz ^{1/2})	(GΩ)	
S16008-33				0.01	5		1.5	0.7	9.0×10^{-16}	2	50
S16008-66	380 to 1100	960	640	0.1	50	1.12	9	4	2.0×10^{-15}	0.2	10
S16008-1010				0.5	200		29	13	2.8×10^{-15}	0.05	5

^{*2:} See reflow soldering conditions (P.9).

Spectral response

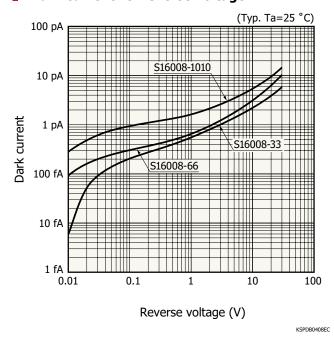


Photosensitivity temperature characteristics

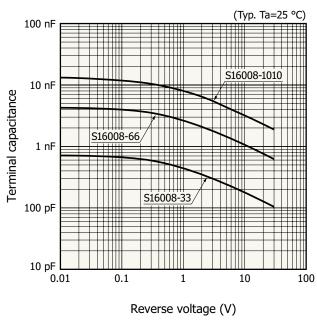


KSPDB0415EA

► Dark current vs. reverse voltage



Terminal capacitance vs. reverse voltage

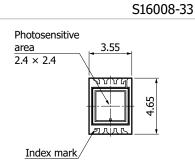


KSPDB0409EC

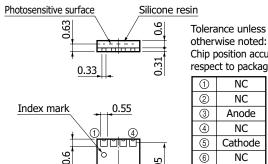
Si photodiodes

S16008 series

Dimensional outlines (unit: mm)



 $P0.8 \times 3 = 2.4$



(8 ×)R0.175

otherwise noted: ±0.1 Chip position accuracy with respect to package center: ±0.1

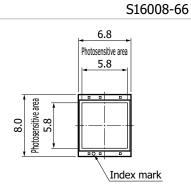
7

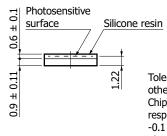
8

NC

NC

KSPDA0223EC



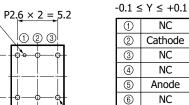


Index mark

5.5

6 (5)

Tolerance unless otherwise noted: ±0.15 Chip position accuracy with respect to package center $-0.1 \le X \le +0.1$

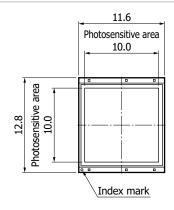


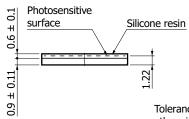
 $(6 \times) \phi 0.6$

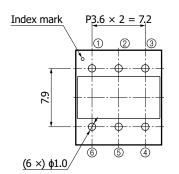
KSPDA0224EB



S16008-1010







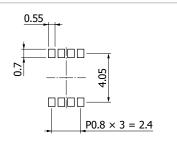
Tolerance unless otherwise noted: ± 0.15 Chip position accuracy with respect to package center $-0.1 \le X \le +0.1$ $-0.1 \le Y \le +0.1$

NC	1
Cathode	2
NC	3
NC	4
Anode	⑤
NC	6

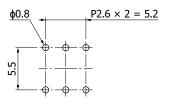
KSPDA0230EA

▶ Recommended land patterns (unit: mm)

S16008-33

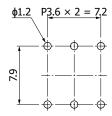


S16008-66



KSPDC0105EA

S16008-1010



KSPDC0109EA

KSPDC0101EA

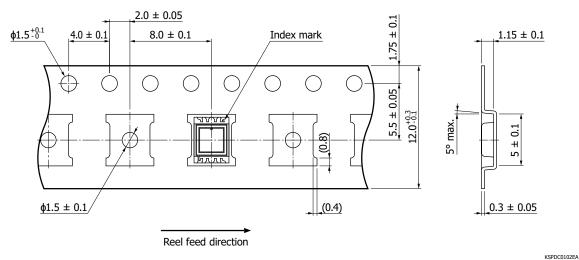
Standard packing specifications

C1C000 22	
\$16008_33	

■ Reel (conforms to JEITA ET-7200)

Outer diameter	Hub diameter	Tape width	Material	Electrostatic characteristics
φ180 mm	ф60 mm	12 mm	PS	Conductive

■ Embossed tape (unit: mm, material: PS, conductive)



- Packing quantity 1000 pcs/reel
- Packing state

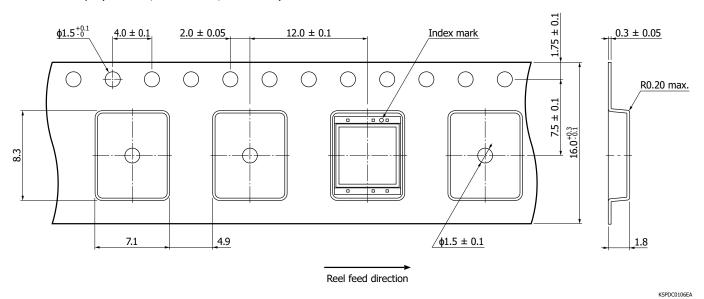
 Reel and desiccant in moisture-proof packaging (vacuum-sealed)

S16008-66

■ Reel (conforms to JEITA ET-7200)

Outer diameter	Hub diameter	Tape width	Material	Electrostatic characteristics
ф330 mm	φ100 mm	16 mm	PS	Conductive

■ Embossed tape (unit: mm, material: PS, conductive)



- Packing quantity 100 pcs/reel
- Packing state
 Reel and desiccant in moisture-proof packaging (vacuum-sealed)

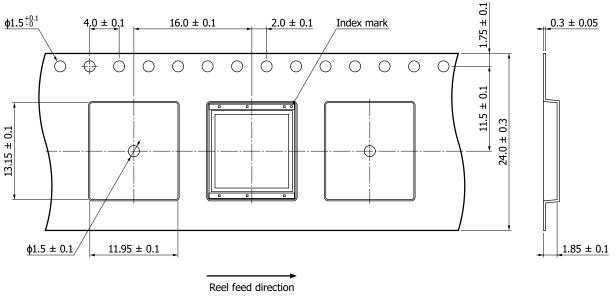


S16008-1010

■ Reel (conforms to JEITA ET-7200)

Outer diameter	Hub diameter	Tape width	Material	Electrostatic characteristics
ф330 mm	φ100 mm	24 mm	PS	Conductive

■ Embossed tape (unit: mm, material: PS, conductive)

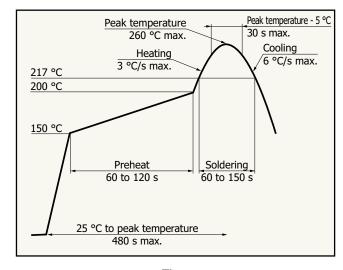


KSPDC0110EA

- Packing quantity 100 pcs/reel
- Packing state

 Reel and desiccant in moisture-proof packaging (vacuum-sealed)

Recommended reflow soldering conditions



· After unpacking, store in an environment at a temperature of 30 °C or less and a humidity of 60% or less, and perform reflow soldering within the storage period shown in the table below.

Type no.	Storage period
S16008-33	4 weeks
S16008-66	168 hours
S16008-1010	72 hours

· The effect that the product receives during reflow soldering varies depending on the circuit board and the reflow oven that are used. When you set reflow soldering conditions, check that problems do not occur in the product by testing out the conditions in advance.

Time

KSPDB0419FA

Baking

Temperature

If 12 months have passed in an unpacked state or the storage period in the table above has passed after opening, perform baking before reflow soldering to dehumidify. For the baking, refer to "Precautions / Surface mount type products" in the related information.

■ Recommended baking conditions

Temperature: 150 °C, 3 hours, up to twice

Note: When you set baking conditions, check that problems do not occur in the product by testing out the conditions in advance.

Related information

www.hamamatsu.com/sp/ssd/doc_en.html

- Precautions
- Disclaimer
- · Precautions / Surface mount type products
- Catalogs
- · Technical note / Si photodiodes

Information described in this material is current as of December 2024.

Product specifications are subject to change without prior notice due to improvements or other reasons. This document has been carefully prepared and the information contained is believed to be accurate. In rare cases, however, there may be inaccuracies such as text errors. Before using these products, always contact us for the delivery specification sheet to check the latest specifications.

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